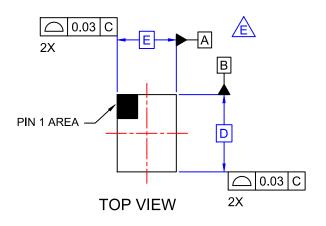
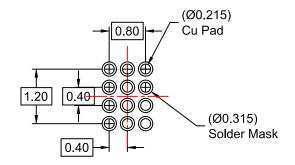


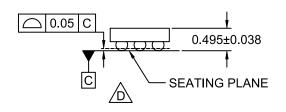
## WLCSP12 1.3x1.8x0.495 CASE 567RA ISSUE O

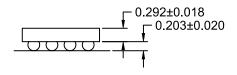
**DATE 31 OCT 2016** 



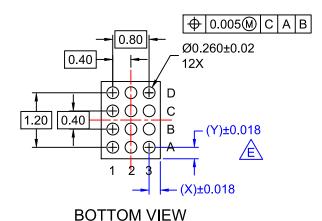


## RECOMMENDED LAND PATTERN (NSMD PAD TYPE)





## SIDE VIEWS



## NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.

DDATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.

FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

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DESCRIPTION:	WLCSP12 1.3x1.8x0.495		PAGE 1 OF 1	

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